

MEG II実験:2021年エンジニアリングランの現状と計画

The MEG II experiment: status and plan of the 2021 engineering run



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on behalf of MEG II collaboration

日本物理学会2021年年次大会
令和3年9月17日

17pT1-4

MEG II in search of $\mu^+ \rightarrow e^+\gamma$

- An **intensity frontier** experiment
- Upgraded from **MEG experiment**
- To get **definitive evidence** for BSM

				
UTokyo KEK Kobe Uni.	PSI ETHZ	INFN Genoa INFN Lecce INFN Pavia INFN Pisa INFN Roma	BINP JINR	UC Irvine
				~60 physicists



MEG result (2016)

$$B(\mu^+ \rightarrow e^+\gamma) < 4.2 \times 10^{-13}$$

@90% C.L.
(while 5.3×10^{-13} expected)

×2 intensity muon beam
×2 resolution everywhere
×2 efficiency

Search for $\mu^+ \rightarrow e^+\gamma$ down to

$$6 \times 10^{-14}$$

(90% C.L. sensitivity)

Ultra-high scale



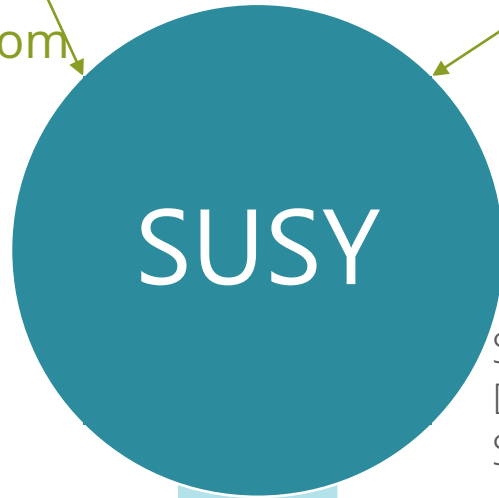
Force unification
Matter unification
Charge quantization



Neutrino mass
Leptogenesis

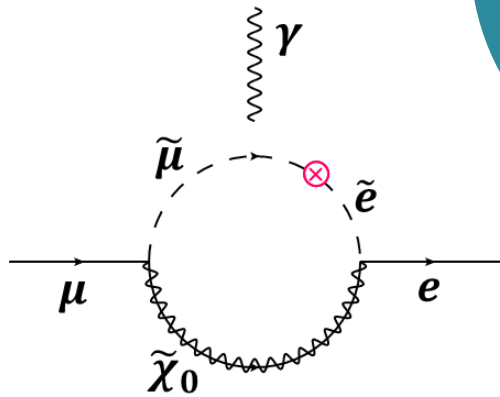
Flavor violation from
quark Yukawa

Flavor violation from
neutrino Yukawa



Spacetime-internal sym. unification
Dark matter?
Solution for hierarchy problem?

TeV scale



LFV
Lepton flavor
violation

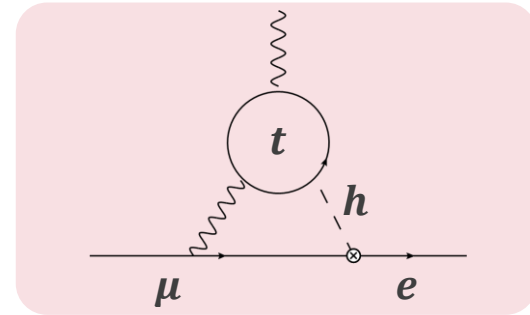
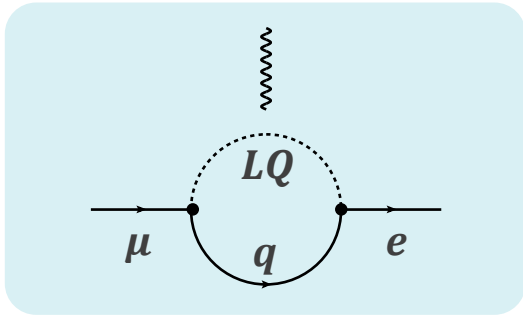
$B(\mu \rightarrow e\gamma) \sim 10^{-11} - 10^{-14}$

Low scale

top-down

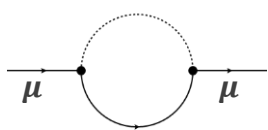
Other reasons

bottom-up

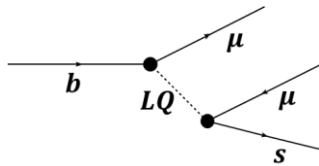


two-loop

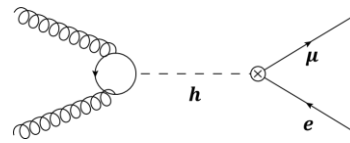
$(g - 2)_\mu$



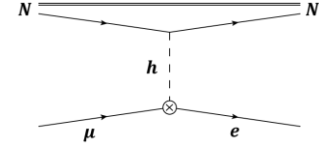
LHCb



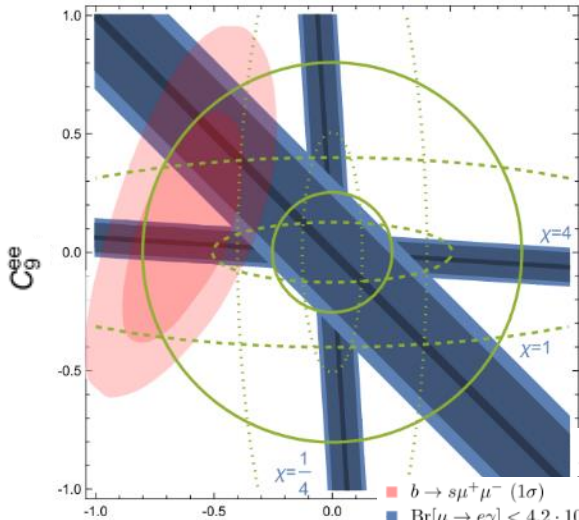
CMS



mu2e/COMET



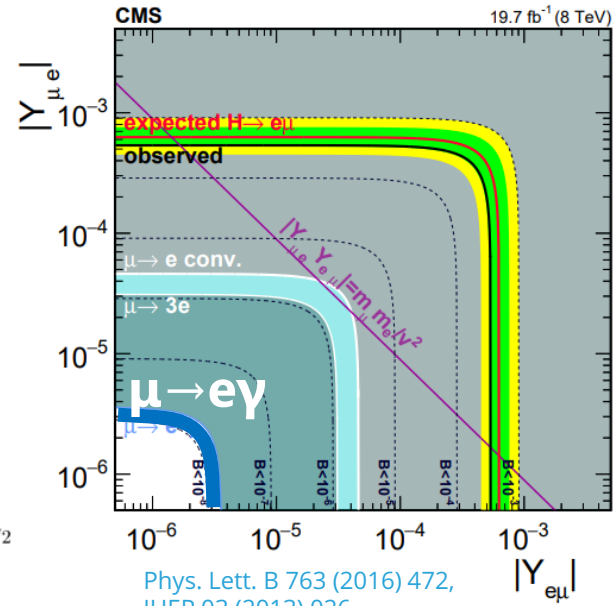
tree



Strong correlation b/w observed anomalies. If new particle couples to electron, it induces sizable $\mu \rightarrow e\gamma$.

$$\chi = y_{32}/y_{21}$$

- $b \rightarrow s\mu^+\mu^-$ (1σ)
- $\text{Br}[\mu \rightarrow e\gamma] < 4.2 \cdot 10^{-13}$ with Φ_3
- $\text{Br}[\mu \rightarrow e\gamma] < 4.2 \cdot 10^{-13}$ with V_1^μ
- $\text{Br}[\mu \rightarrow e\gamma] < 4.2 \cdot 10^{-13}$ with V_3^μ
- $b \rightarrow s\mu^+\mu^-$ (2σ)
- $\text{Br}[B \rightarrow K\mu^\pm e^\mp]$ with $\gamma = 1/2$
- $\text{Br}[B \rightarrow K\mu^\pm e^\mp]$ with $\gamma = 1$
- $\text{Br}[B \rightarrow K\mu^\pm e^\mp]$ with $\gamma = 2$



Limit on $\mu \rightarrow e\gamma$ provides the most stringent limit on the LFV Higgs decay $\text{BR}(h \rightarrow \mu e) < 10^{-8}$
(CMS limit: $\text{BR}(h \rightarrow \mu e) < 3.5 \times 10^{-4}$)

MEG II

[EPJ-C 78 \(2018\) 380](#)

Thin-wall SC solenoid
(gradient B-field: 1.3→0.5 T)

Liquid xenon photon detector
($\epsilon_{\gamma} \sim 70\%$, $\sigma_E/E \sim 1\%$)

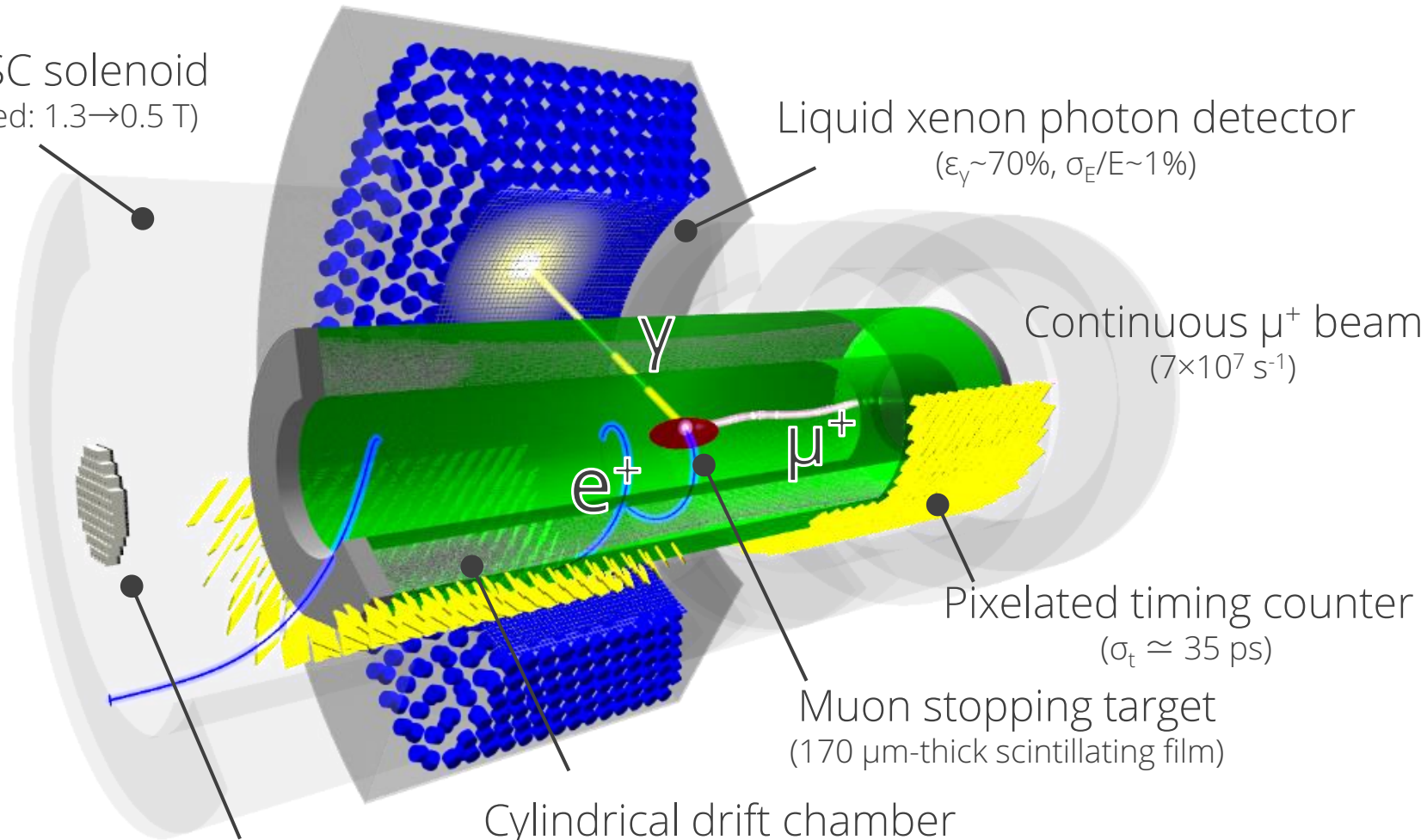
Continuous μ^+ beam
($7 \times 10^7 \text{ s}^{-1}$)

Pixelated timing counter
($\sigma_t \approx 35 \text{ ps}$)

Muon stopping target
(170 μm -thick scintillating film)

Cylindrical drift chamber
($\sim 1.6 \times 10^{-3} X_0$, $\sigma_p \sim 100 \text{ keV}$)

Radiative decay counter
(identify high-energy BG γ events)



Current status & outstanding issues



All the apparatus has been constructed.
Each detector has been tested in beam so far.

To be studied

1

Electronics

Full electronics has not yet been tested.

2

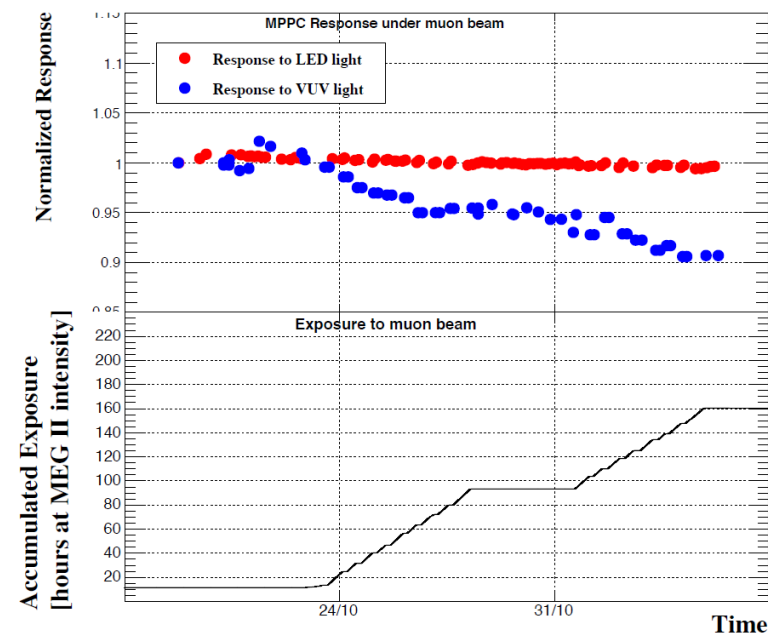
LXe detector

Lack of study with full channel readout.
Degradation of MPPC PDE.
Evaluation of timing resolution.

3

Drift chamber

Stable operation of the detector in beam.
Bad S/N.
Lack of tracking study due to limited electronics.



2020年年次大会、小林

Goal of 2021



To address all the issues.

To setup $\mu \rightarrow e\gamma$ trigger and collect the initial data of MEG II.

To be studied

1

Electronics

Full electronics has not yet been tested.

⇒ Complete production & deploy

2

LXe detector

Lack of study with full channel readout.
Degradation of MPPC PDE.
Evaluation of timing resolution.

⇒ Long-term study in beam.

⇒ New measurement with improved setup.

3

Drift chamber

Stable operation of the detector in beam.
Bad S/N.
Lack of tracking study due to limited electronics.

⇒ Long-term study in beam.

⇒ Noise investigation under final condition.



33 crates, 8500 channels

1

Electronics

Mass-production finished & installed in Mar.

DAQ with the full channels in operation

Basically, the system works (debugging ongoing).

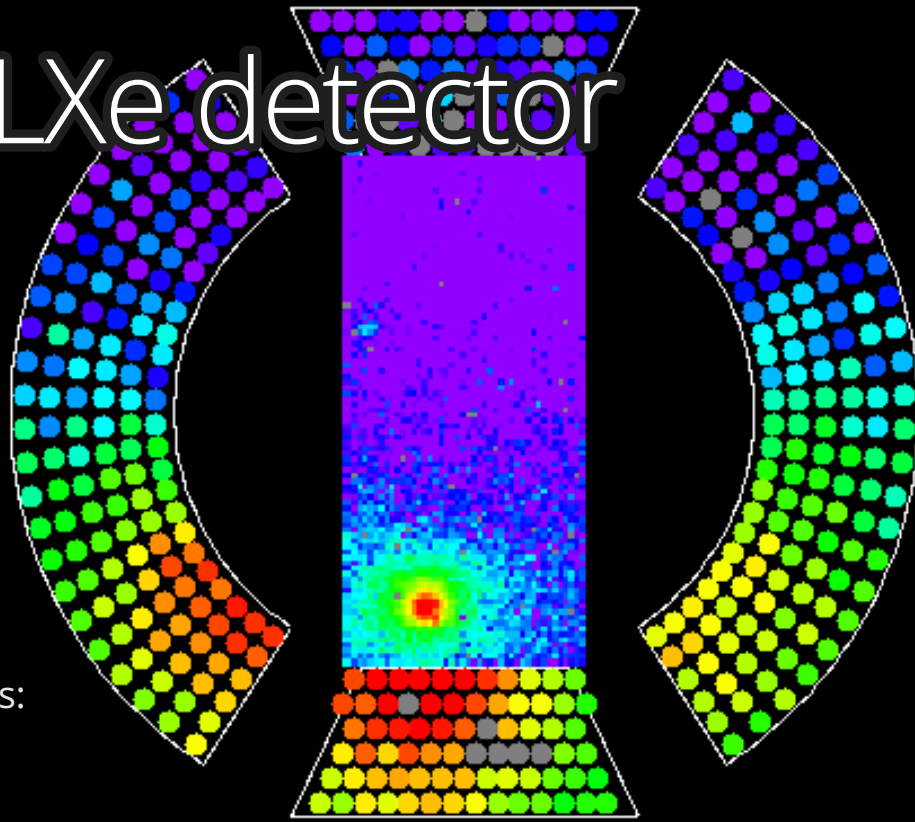
Stable DAQ at data rate of **1.5 Gbps**. ~2 TB/day in storage.

Better noise situation for LXe, but **worse** for pTC.

2

LXe detector

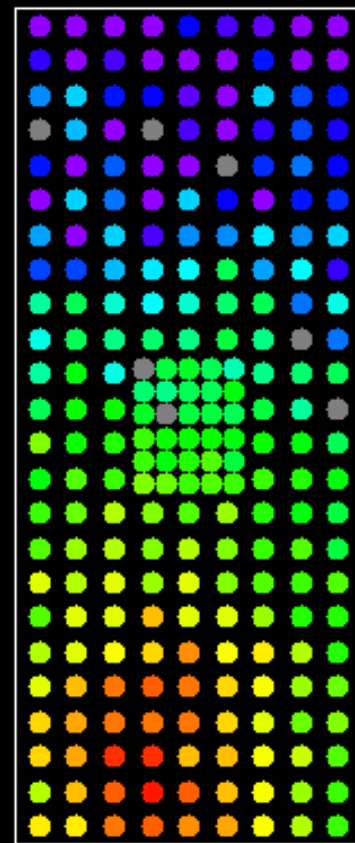
100
80
60
40
20
0



Bad channels:
MPPC 28 ch
PMT 27 ch

Not a simulation!

4092 MPPCs + 668 PMTs



500.00
209.47
99.37
47.14
22.36
9.37
4.44
2.11
1.00

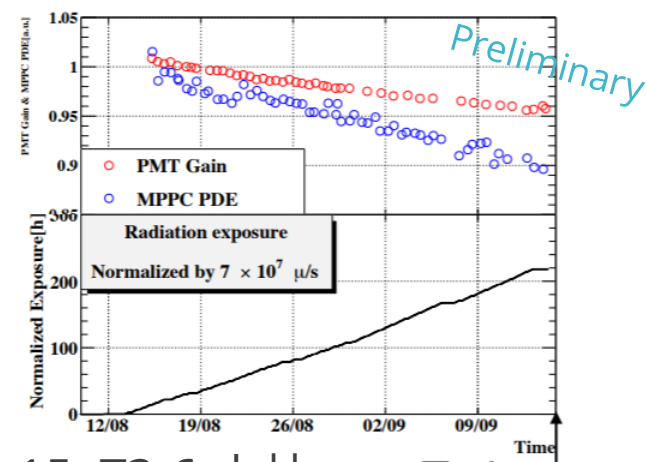
9

Commissioning with the full electronics done.
Calibration & monitoring continued.

Using beam from mid. Aug (~1 month)

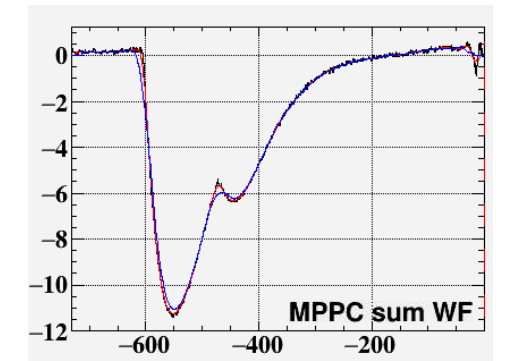
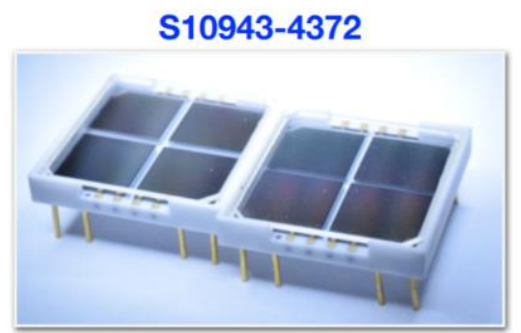
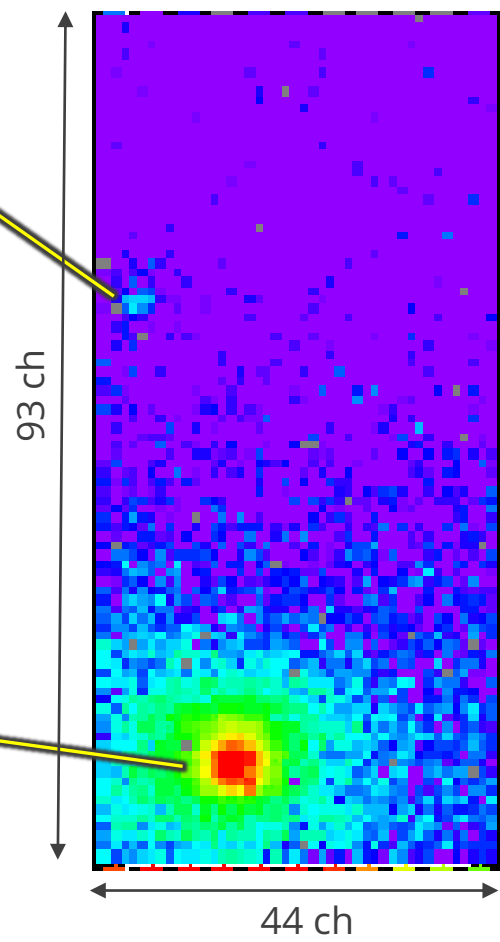
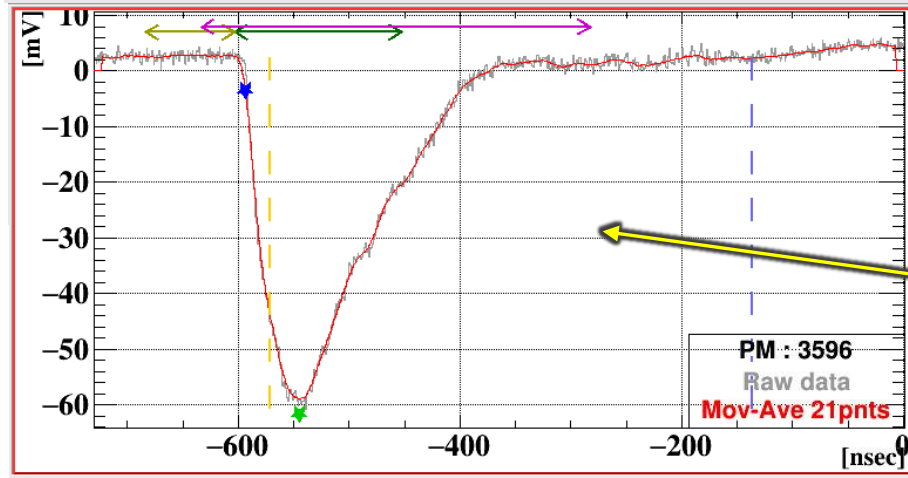
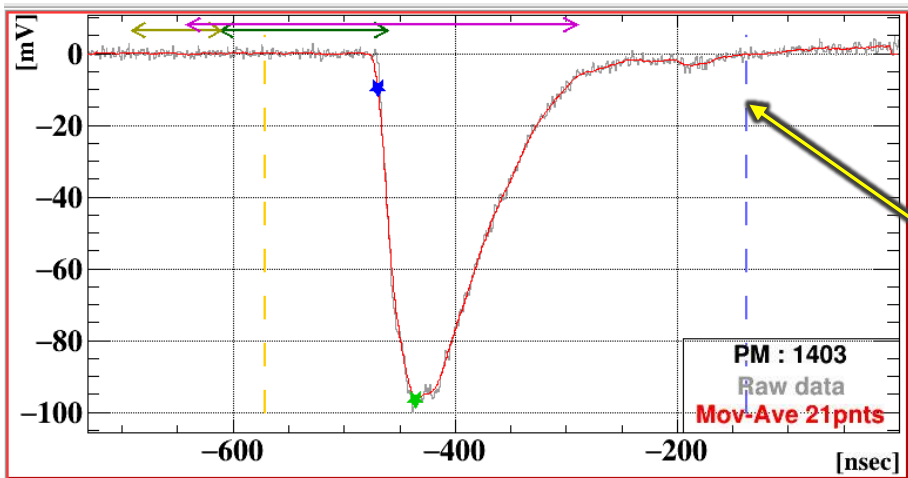
- ▣ To study the MPPC PDE decrease.
- ▣ Basically, confirmed previous observations (preliminary).
→ No sign of saturation of the degradation.

September 17, 2021
YUSUKE UCHIYAMA



15pT3-6 小林

Today

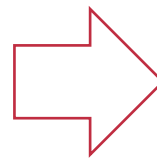


High granularity readout

4092 MPPCs + 668 PMTs

Waveform data for the 4760 channels

1024 points @ 1.4 GSPS



Pileup identification & unfolding

See 15pT3-7 恩田

3 Drift chamber

Conditioning done

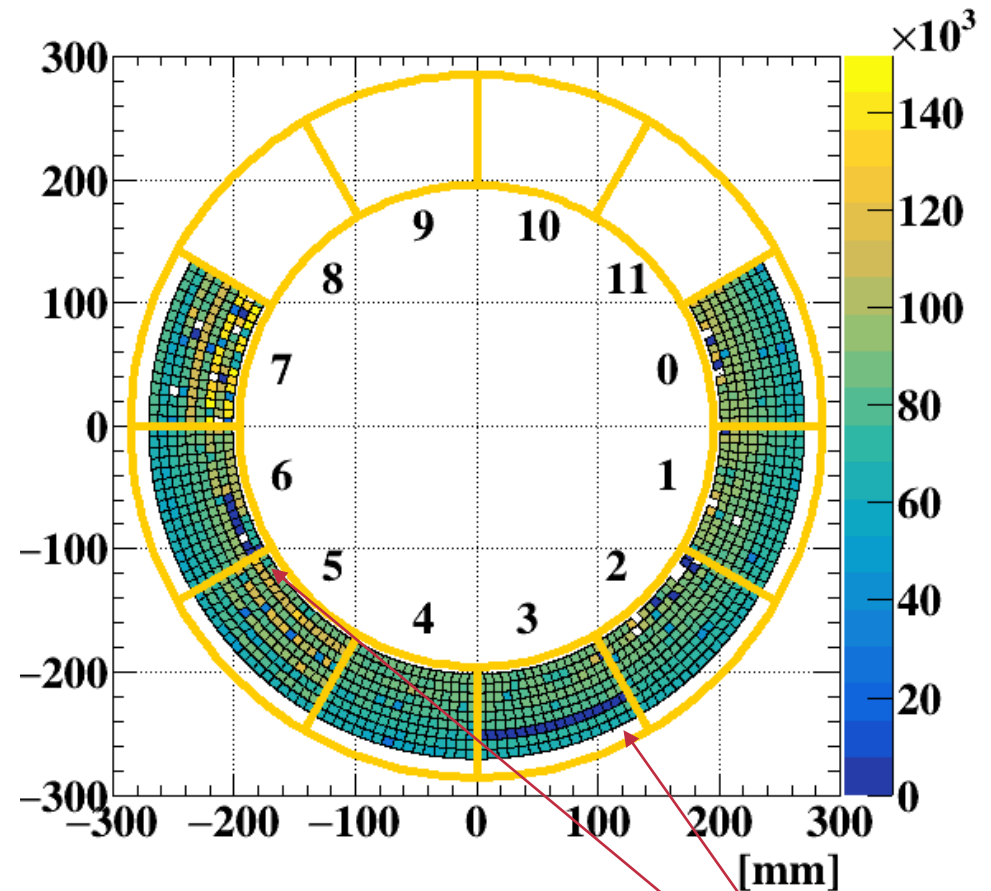
- ❑ In beam with high concentration of O_2 (2%).
- ❑ High current (corona discharge) is reducing.
- ❑ Gas mixture: $He:iC_4H_{10}(90:10)$
+ 1.2% 2-propanol + 0.5% O_2

Noise study

- ❑ Identified several sources of noise.
- ❑ Some were fixed, others require hardware modification.

Tracking study started

- ❑ Cosmic ray and e^+ from muon decay.
- ❑ Calibration and alignment are underway.

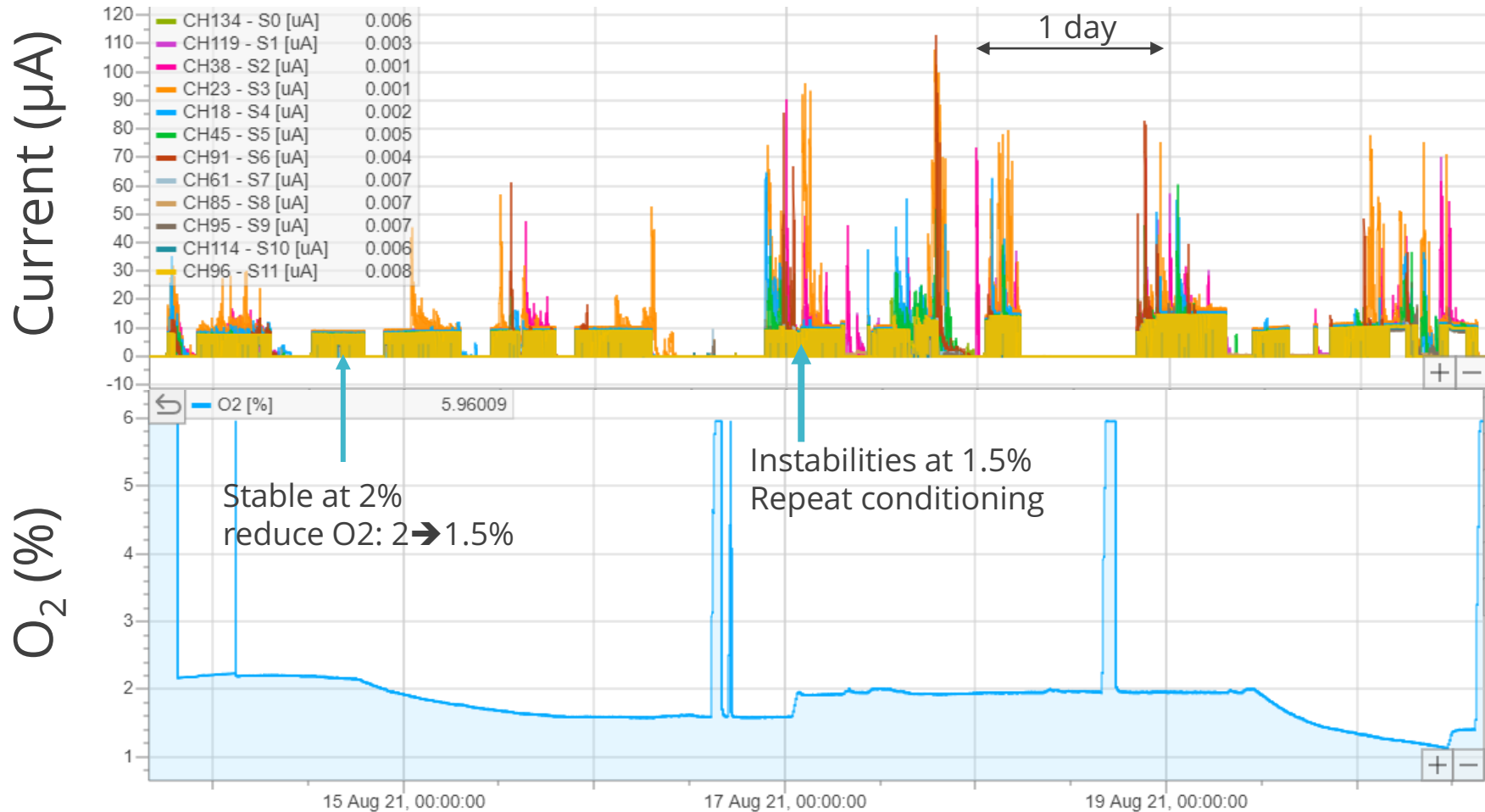


58 bad cells (/1280 cells)

- 7 missing anodes
- 13 short

HV cable disconnected

Conditioning in beam



Building new drift chamber

Risk of wire breaking

- ❑ Exposure to humidity during the construction
- ❑ Bad coating (Ag) due to an ultra-finishing process to make 40- μm wire

We decided to construct another drift chamber

- ❑ Use 50- μm Ag-coated Al wires without the finishing process (California Fine Wire)
- ❑ Recover the original 10-layer configuration.
(Existing chamber has 9 layers due to construction schedule.)
- ❑ Modify/improve some parts based on the experience of the 1st chamber.

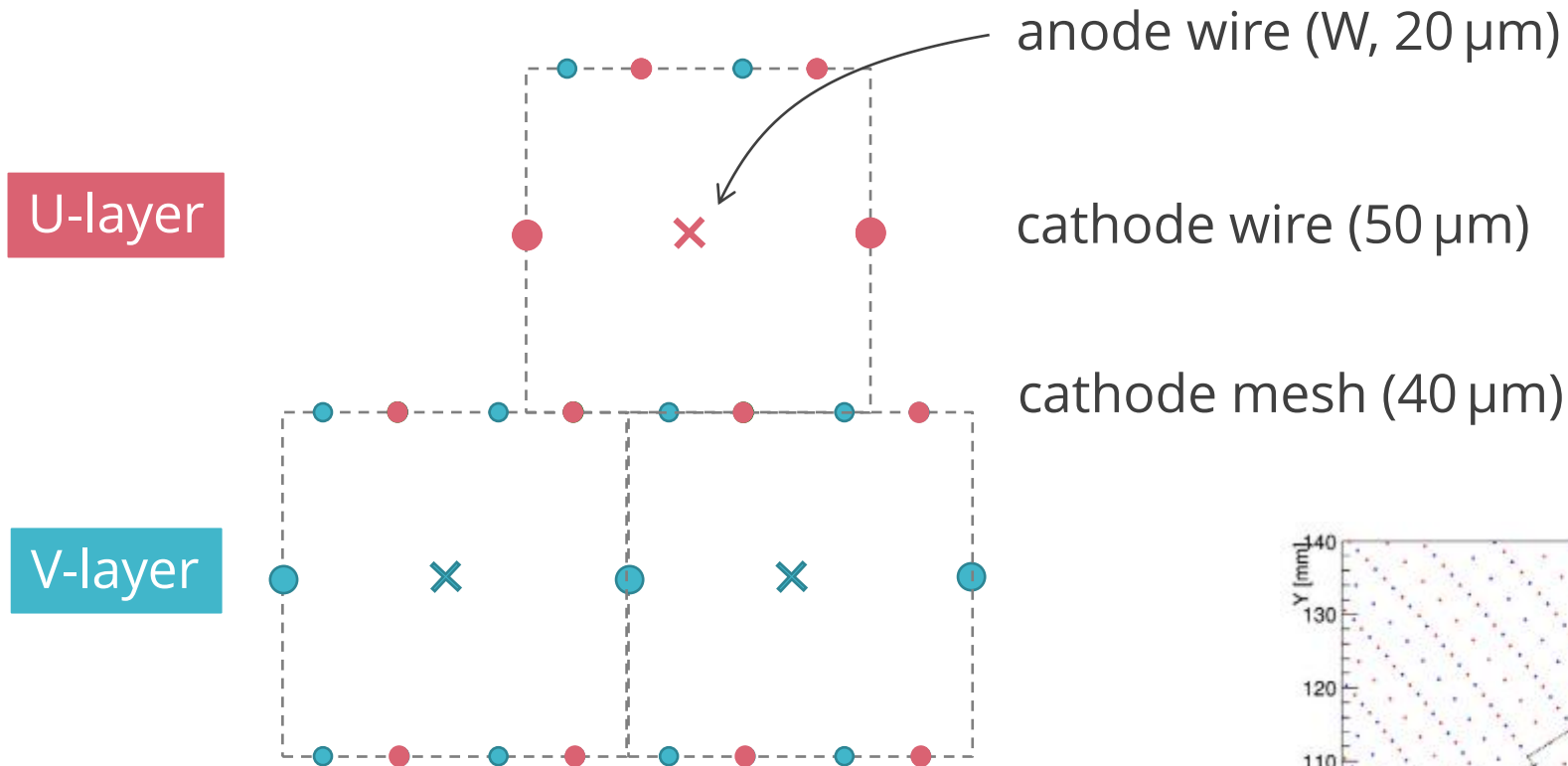
Schedule

- ❑ Budget secured (Italy).
- ❑ Material procurement started.
- ❑ Wiring takes 62 weeks.
- ❑ Complete by Mar. 2023.
→ Use it from 2023 run.

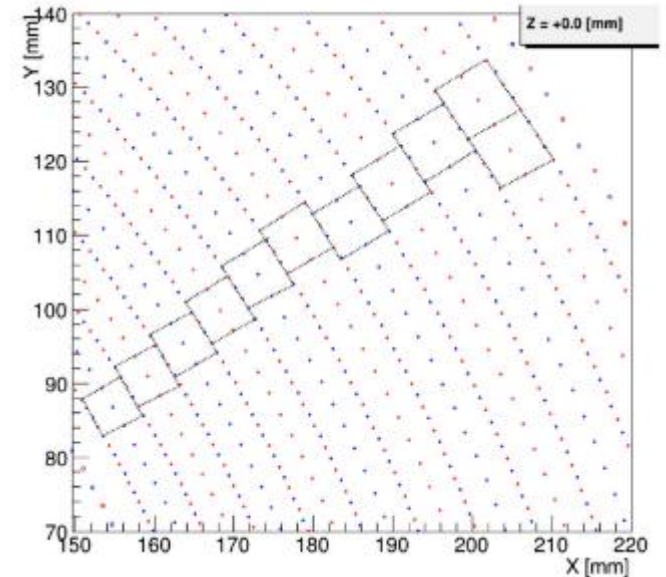


Wiring machine re-assembled in INFN-Pisa

Drift cell configuration



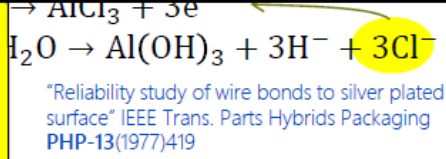
In the new CDCH, 50 μm wire will be used also for the cathode mesh.



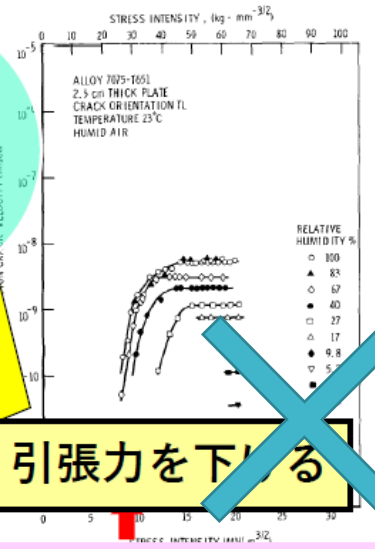
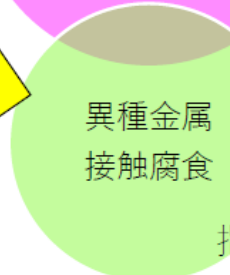
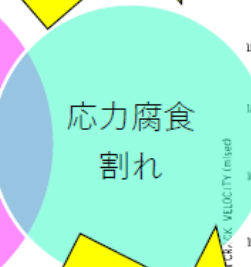
Corrosion (腐食)



湿度を下げる、
チャンバーを封じる



腐食
電気化学



上質なコーティング
or
コーティングなし

引張力を下げる

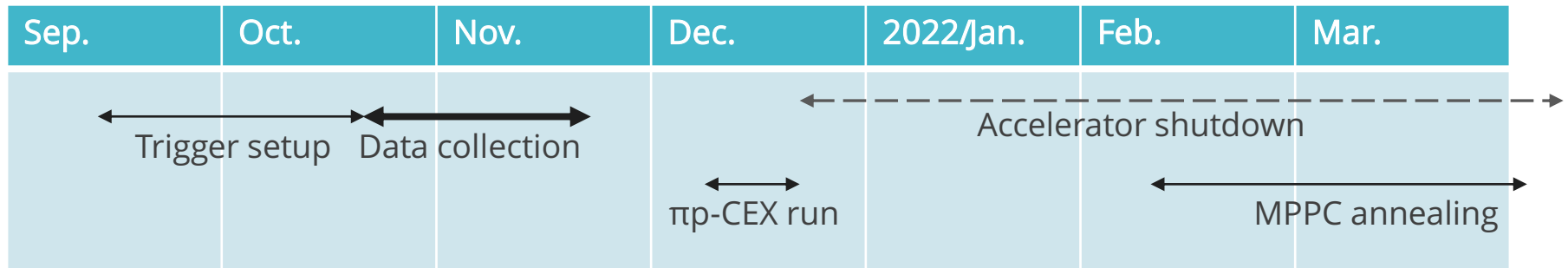
腐食に弱いアルミワイヤーにこだわる??

静電気に耐えるために下げられない。

アルミと銀の境界 + 水分 + 張力 = 腐食による断線

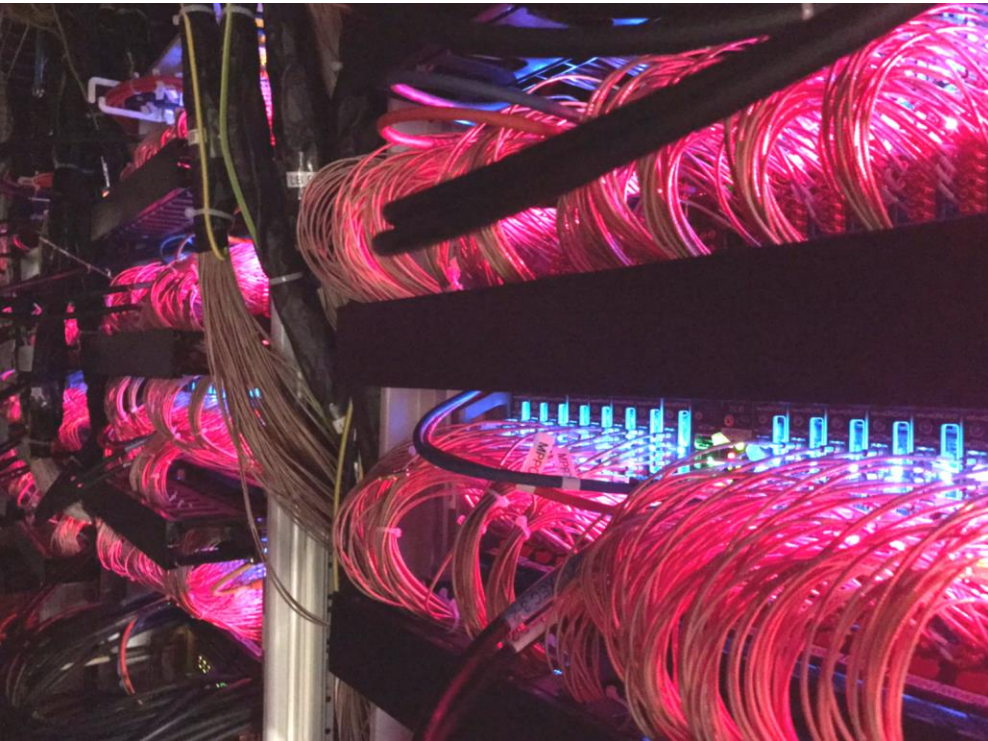
陰極ワイヤ: 40 or 50 μm 銀コーティングアルミニウムワイヤ

Schedule



- $\mu \rightarrow e\gamma$ trigger setup is starting now.
- Collect $\mu \rightarrow e\gamma$ trigger data until Nov.
This will be the first MEG II physics data
- Performance evaluation with $\pi\mu$ charge-exchange reaction in Dec.
Measure energy resolution with full elec.
Improve method for the measurement of timing resolution.
- Perform MPPC annealing in the next spring.
Annealing was not performed in the last shutdown period.
Study of the procedure is underway

Summary



The MEG II engineering run is underway,

- ❑ Finally with the full readout electronics.
- ❑ All the detectors were installed and under commissioning in beam.
- ❑ Beamtime continues until Dec.

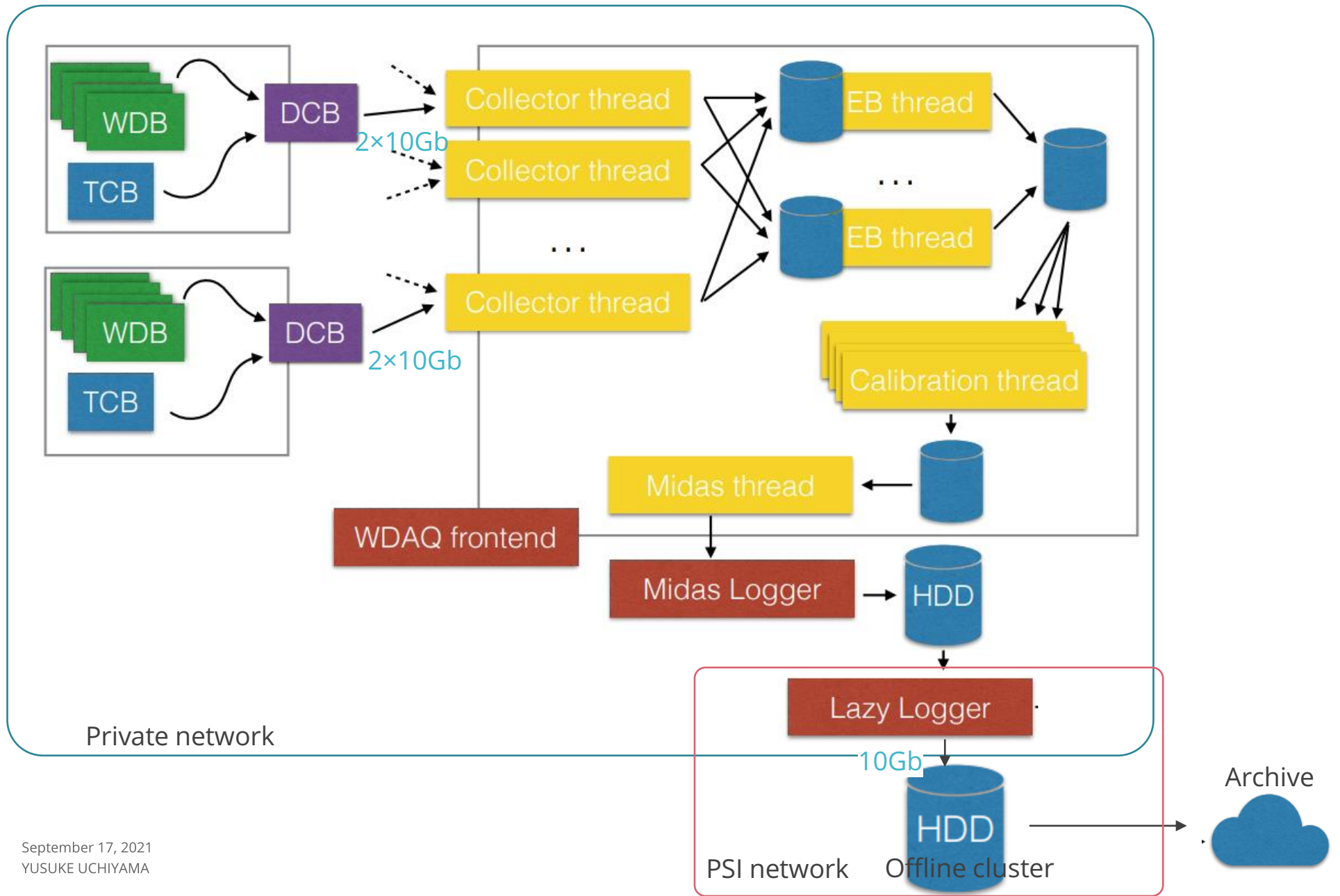
The main goals are

- ❑ To study & understand the LXe MPPC PDE decrease phenomenon and decide the operation scenario.
- ❑ To achieve stable operation of CDCH.
- ❑ To establish the $\mu \rightarrow e\gamma$ trigger and **begin the physics data collection.**

Recently, **Kobe University** group has officially joined the MEG II collaboration., contributing to the development of upstream RDC with unique RPC technique.

Dataflow

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Readout electronics

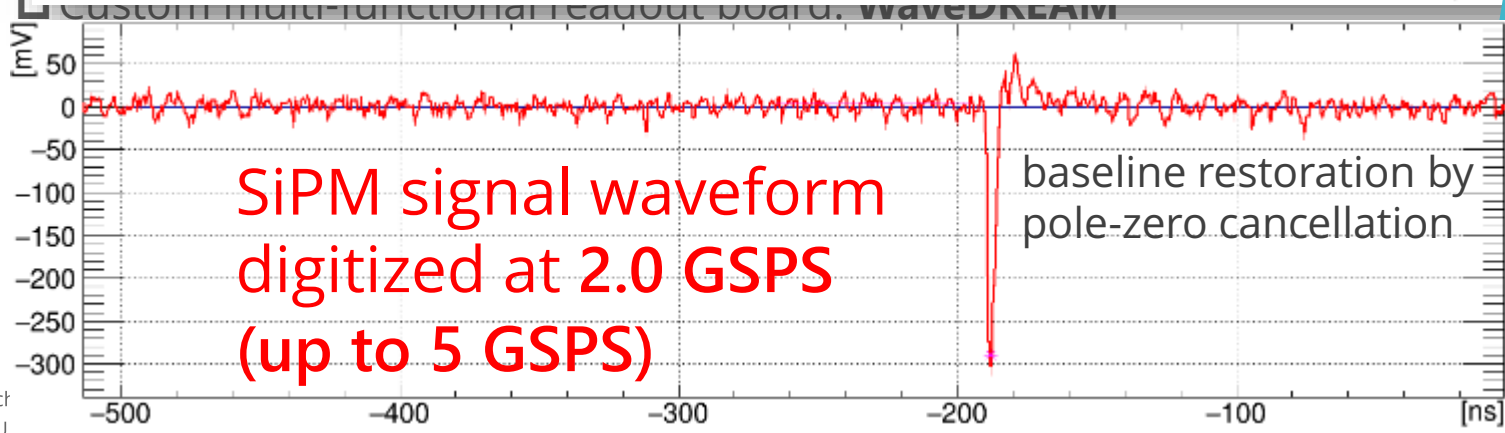
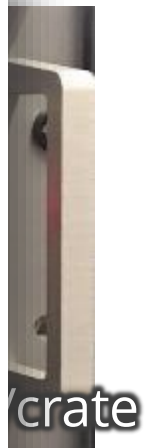
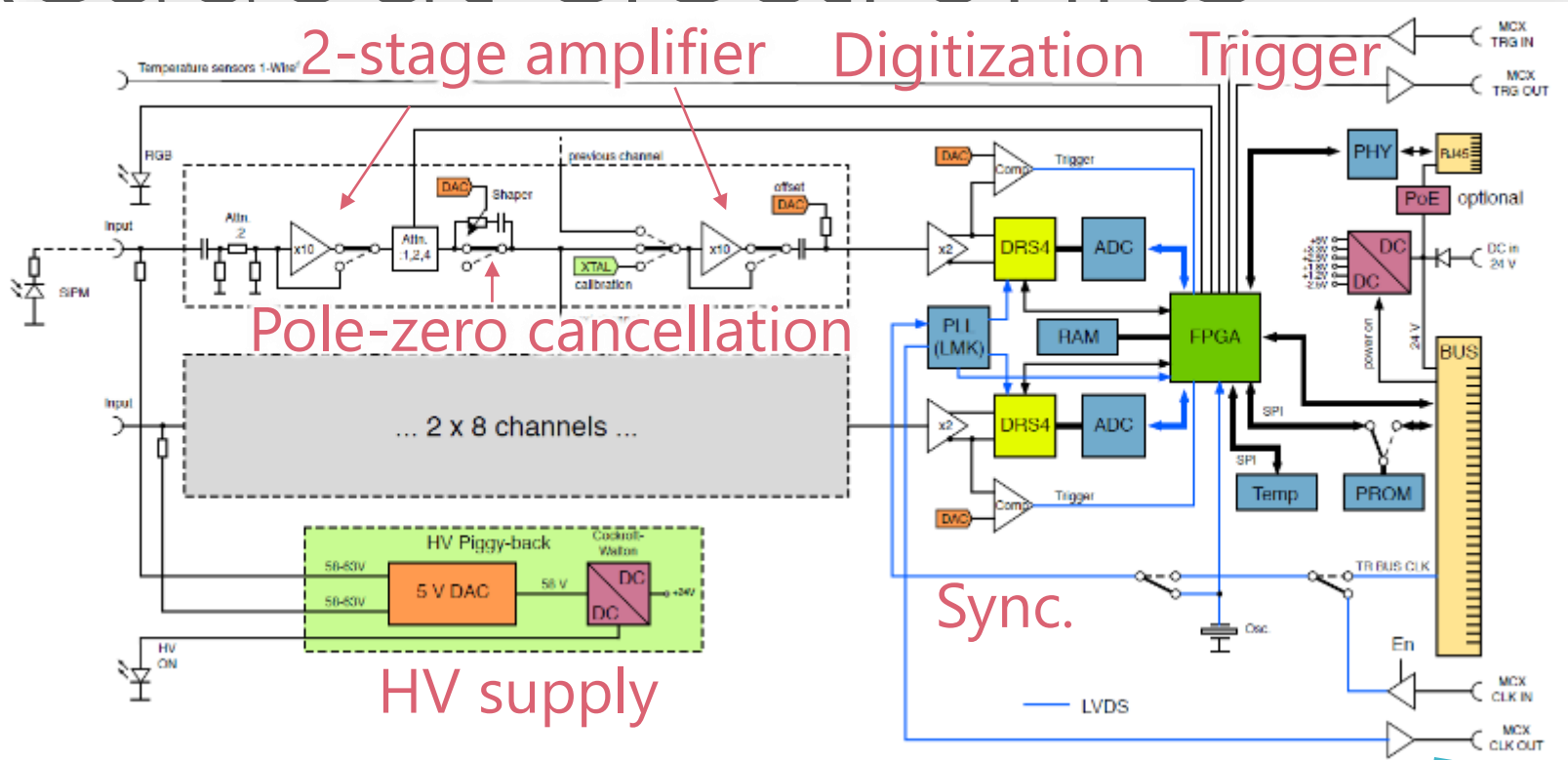


- New DAQ/Trigger system

- Use it for all MEG-II detectors in common
- Dense & compact system to cope with increased # of channels.
- Custom multi-functional readout board: **WaveDREAM**
 - Analog FE (programmable shaper & amplifier),
 - SiPM bias-voltage supply, waveform sampling (DRS4),
 - digitization, discriminator, FPGA-based trigger in one module
 - No pre-amplifier at detector side
- Synchronization accuracy < 20 ps (over different crate module)



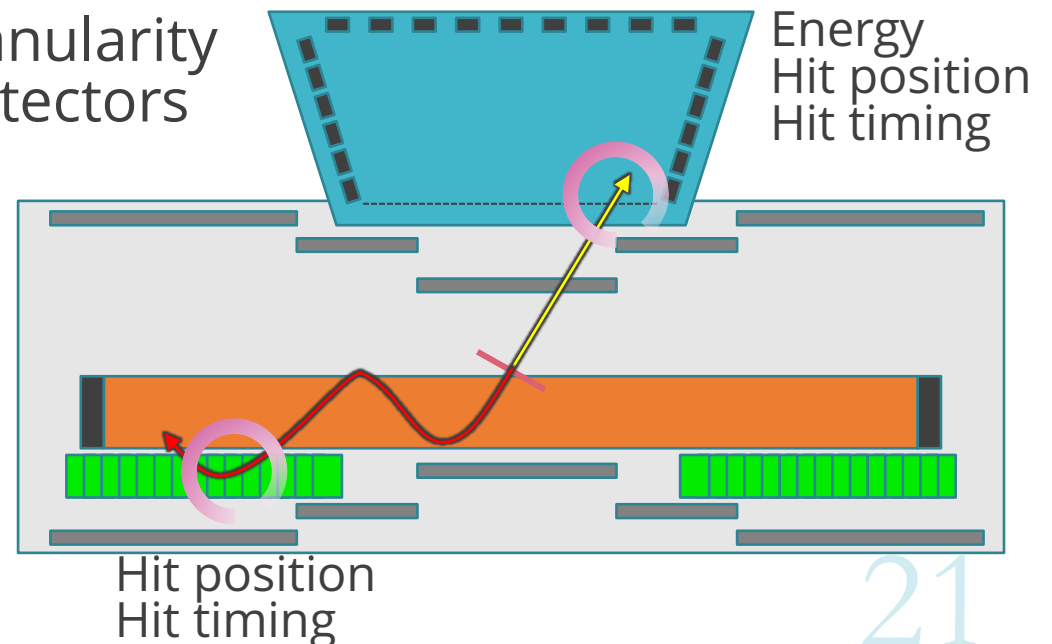
Readout electronics



20

Trigger

- More efficient trigger is indispensable.
- Trigger logics (basically same as MEG)
 1. Gamma-ray energy threshold
 2. Time coincidence
 3. e- γ direction matching (close to 180°)
- Improve by use of higher granularity & better resolution of the detectors



Wire conditioning, aging, & additives

Conditioning (HV training)

Eliminate dust, contamination, deposit.
Necessary to apply HV after opening chamber or after aging.

Wire aging (in He:iC₄H₁₀)

Polymer formations by radicals (of HC) created in avalanche.

Anode aging:

Gain decrease (thicker wire), gain non-uniformity along wire.

Cathode aging:

Self-sustain high current and discharge by Malter effect.

Additives to mitigate/recover from aging

Alcohols (in our case 2-propanol)

Reduction of polymerization rate

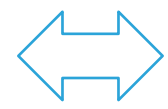
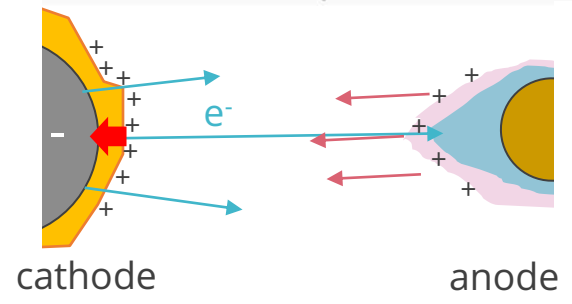
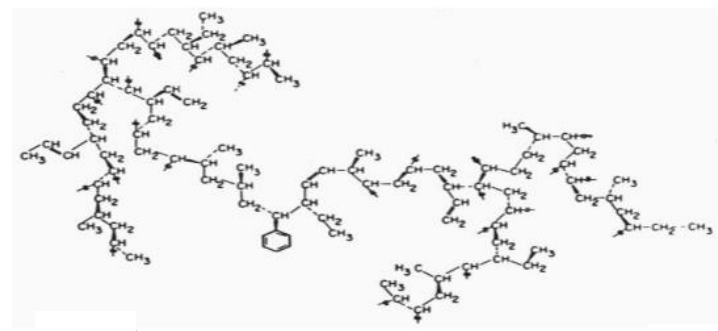
Absorption of UV photons

O₂

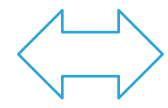
Etching (cleaning) of HC-deposit

React with HC, becoming stable and volatile

Capture e⁻ emitted from Malter effect.



Reduction in gas gain



Reduction of primary e⁻

Low-mass drift chambers

	Gas	Cell size	Sense wire	Field wire	
CLEO II	Ar:C ₂ H ₆ 50:50	14 mm	20- μ m Au-W	110- μ m Au- Al , 110- μ m Cu/Be	Crimp
BESIII	He:C ₃ H ₈ 60:40	12–16.2 mm	25- μ m Au-W	110- μ m Au- Al	Crimp
Belle II	He:C ₂ H ₆ 50:50	6–18 mm	30- μ m Au-W	126- μ m Al	Crimp
COMET-Phase I	He:iC ₄ H ₁₀ 90:10	16–16.8 mm	25- μ m Au-W	126- μ m Al	Crimp
KLOE	He:iC ₄ H ₁₀ 90:10	20–30 mm	25- μ m Au-W	81- μ m Ag- Al	Crimp
MEG II	He:iC ₄ H ₁₀ 90:10	6.6–9 mm	20- μ m Au-W	40- μ m Ag- Al	Solder

- **KLOE** used same type of wire without any problem for **>10 years**
Constructed under 50% R.H., never observed salt formation

Type	X ₀ (mm)	$\langle X \rangle^{wires}$ (10 ⁻³ X ₀)	$\langle X \rangle^{tot}$ (10 ⁻³ X ₀)	θ_{MCS}^{wires} (mrad)	θ_{MCS}^{tot} (mrad)
Al (5056)	89	0.72	1.5	5	7.6
Ti	36	1.26	2.1	6.8	9
CuBe	14.7	2.58	3.4	10.1	11.7
Stainless Steel (302)	17.8	2.2	3	9.3	11

Other material than Al is **not acceptable** from the resolution point of view.

- **Bare Al wire** could be a better alternative, but difficulty in soldering.
(Naturally coated by Al₂O₃)